

## Single Socket CardBus Controller with Integrated 1394a-2000 OHCI One-Port PHY/Link-Layer Controller

### FEATURES

- *PC Card Standard 8.1* Compliant
- *PCI Bus Power Management Interface Specification 1.1* Compliant
- *Advanced Configuration and Power Interface (ACPI) Specification 2.0* Compliant
- *PCI Local Bus Specification Revision 2.3* Compliant
- PC 98/99 and PC2001 Compliant
- Windows Logo Program 2.0 Compliant
- *PCI Bus Interface Specification for PCI-to-CardBus Bridges*
- 1.5-V Core Logic and 3.3-V I/O Cells With Internal Voltage Regulator to Generate 1.5-V Core  $V_{CC}$
- Universal PCI Interfaces Compatible With 3.3-V and 5-V PCI Signaling Environments
- Supports PC Card or CardBus With Hot Insertion and Removal
- Supports 132-MBPS Burst Transfers to Maximize Data Throughput on Both the PCI Bus and the CardBus
- Supports Serialized IRQ With PCI Interrupts
- Programmable Multifunction Terminals
- Many Interrupt Modes Supported
- Serial ROM Interface for Loading Subsystem ID and Subsystem Vendor ID
- ExCA-Compatible Registers Are Mapped in Memory or I/O Space
- Intel 82365SL-DF Register Compatible
- Supports Ring Indicate,  $\overline{SUSPEND}$ , and PCI  $\overline{CLKRUN}$  Protocols and PCI Bus Lock ( $\overline{LOCK}$ )
- Provides VGA/Palette Memory and I/O, and Subtractive Decoding Options, LED Activity Terminals
- Fully Interoperable With FireWire™ and i.LINK™ Implementations of IEEE Std 1394
- Compliant With *Intel Mobile Power Guideline 2000*
- Fully Compliant With Provisions of IEEE Std 1394-1995 for a High-Performance Serial Bus and IEEE Std 1394a-2000
- Fully Compliant With *1394 Open Host Controller Interface Specification 1.1*
- Full IEEE Std 1394a-2000 Support Includes: Connection Debounce, Arbitrated Short Reset, Multispeed Concatenation, Arbitration Acceleration, Fly-by Concatenation, And Port Disable/Suspend/Resume
- Power-Down Features to Conserve Energy in Battery-Powered Applications Include: Automatic Device Power Down During Suspend, PCI Power Management for Link-Layer, and Inactive Ports Powered Down, Ultralow-Power Sleep Mode
- A IEEE Std 1394a-2000 Fully Compliant Cable Port at 100M Bits/s, 200M Bits/s, and 400M Bits/s
- Cable Port Monitors Line Conditions for Active Connection to Remote Node
- Cable Power Presence Monitoring
- Separate Cable Bias (TPBIAS) for the Port
- Physical Write Posting of Up To Three Outstanding Transactions
- PCI Burst Transfers and Deep FIFOs to Tolerate Large Host Latency
- External Cycle Timer Control for Customized Synchronization
- Extended Resume Signaling for Compatibility With Legacy DV Components
- PHY-Link Logic Performs System Initialization and Arbitration Functions
- PHY-Link Encode and Decode Functions Included for Data-Strobe Bit Level Encoding
- PHY-Link Incoming Data Resynchronized to Local Clock
- Low-Cost 24.576-MHz Crystal Provides Transmit and Receive Data at 100M Bits/s, 200M Bits/s, and 400M Bits/s



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- **Node Power Class Information Signaling For System Power Management**
- **Register Bits Give Software Control Of Contender Bit, Power Class Bits, Link Active Control Bit, and IEEE Std 1394a-2000 Features**
- **Isochronous Receive Dual-Buffer Mode**
- **Out-Of-Order Pipelining for Asynchronous Transmit Requests**
- **Register Access Fail Interrupt When the PHY SCLK Is Not Active**
- **PCI Power-Management D0, D1, D2, and D3 Power States**
- **Initial Bandwidth Available and Initial Channels Available Registers**
- **PME Support Per *1394 Open Host Controller Interface Specification***
- **Advanced Submicron, Low-Power CMOS Technology**

## DESCRIPTION

The Texas Instruments PCI4515A controller is an integrated single-socket PC Card controller, IEEE 1394 open HCI host controller and PHY. This high-performance integrated solution provides the latest in PC Card and IEEE 1394 technology.

The controller is a two-function PCI controller compliant with *PCI Local Bus Specification*, Revision 2.3.

Function 0 provides an independent PC Card socket controllers compliant with the *PC Card Standard* (Release 8.1). The controller provides features that make it the best choice for bridging between the PCI bus and PC Cards, and supports 16-bit, CardBus, or USB custom card interface PC Cards, powered at 5 V or 3.3 V, as required.

All card signals are internally buffered to allow hot insertion and removal without external buffering. The controller is register compatible with the Intel 82365SL-DF ExCA controller. The internal data path logic allows the host to access 8-, 16-, and 32-bit cards using full 32-bit PCI cycles for maximum performance. Independent buffering and a pipeline architecture provide an unsurpassed performance level with sustained bursting. The controller can be programmed to accept posted writes to improve bus utilization.

Function 2 of the controller is compatible with IEEE Std 1394a-2000 and the latest *1394 Open Host Controller Interface Specification*. The chip provides the IEEE1394 link and 1-port PHY function and is compatible with data rates of 100, 200, and 400 Mb/s per second. Deep FIFOs are provided to buffer 1394 data and accommodate large host bus latencies. The controller provides physical write posting and a highly tuned physical data path for SBP-2 performance.

Various implementation-specific functions and general-purpose inputs and outputs are provided through eight multifunction terminals. These terminals present a system with options in PCI  $\overline{\text{LOCK}}$ , serial and parallel interrupts, PC Card activity indicator LEDs, and other platform-specific signals. PCI-compliant general-purpose events may be programmed and controlled through the multifunction terminals, and an ACPI-compliant programming interface is included for the general-purpose inputs and outputs.

The controller is compliant with the latest *PCI Bus Power Management Specification*, and provides several low-power modes, which enable the host power system to further reduce power consumption.

The controller also has a three-pin serial interface compatible with the Texas Instruments TPS2228 (default), TPS2226, TPS2224, TPS2223A, and TPS2220 power switches. All five power switches provide power to the CardBus socket on the controller.

### NOTE:

This product is for high-volume PC applications only. For a complete datasheet or more information contact support@ti.com.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
PCI4515AGHK	OBSOLETE	BGA MI CROSTAR	GHK	257		TBD	Call TI	Call TI
PCI4515AZHK	OBSOLETE	BGA MI CROSTAR	ZHK	257		TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

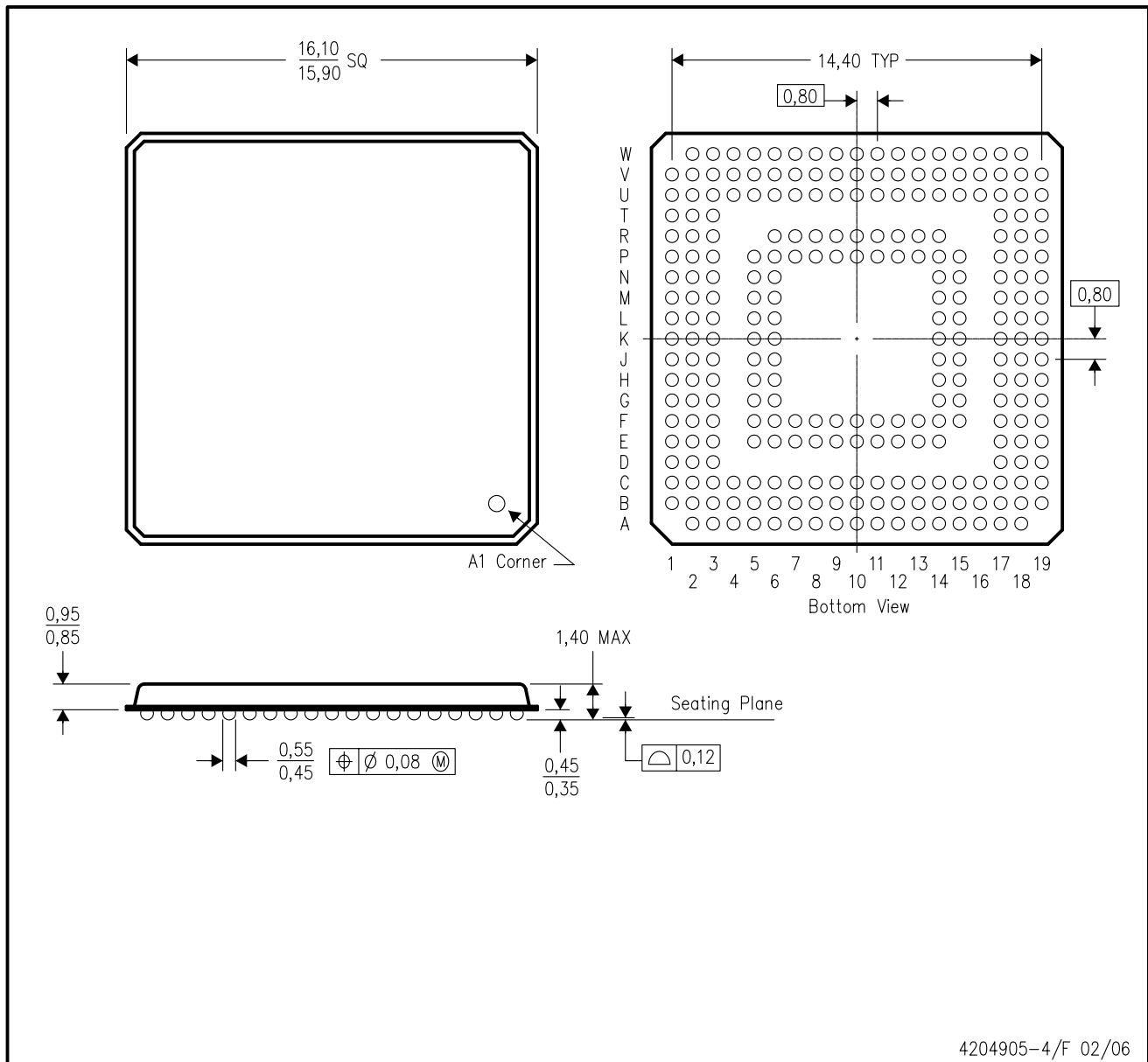
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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ZHK (S-PBGA-N257)

PLASTIC BALL GRID ARRAY

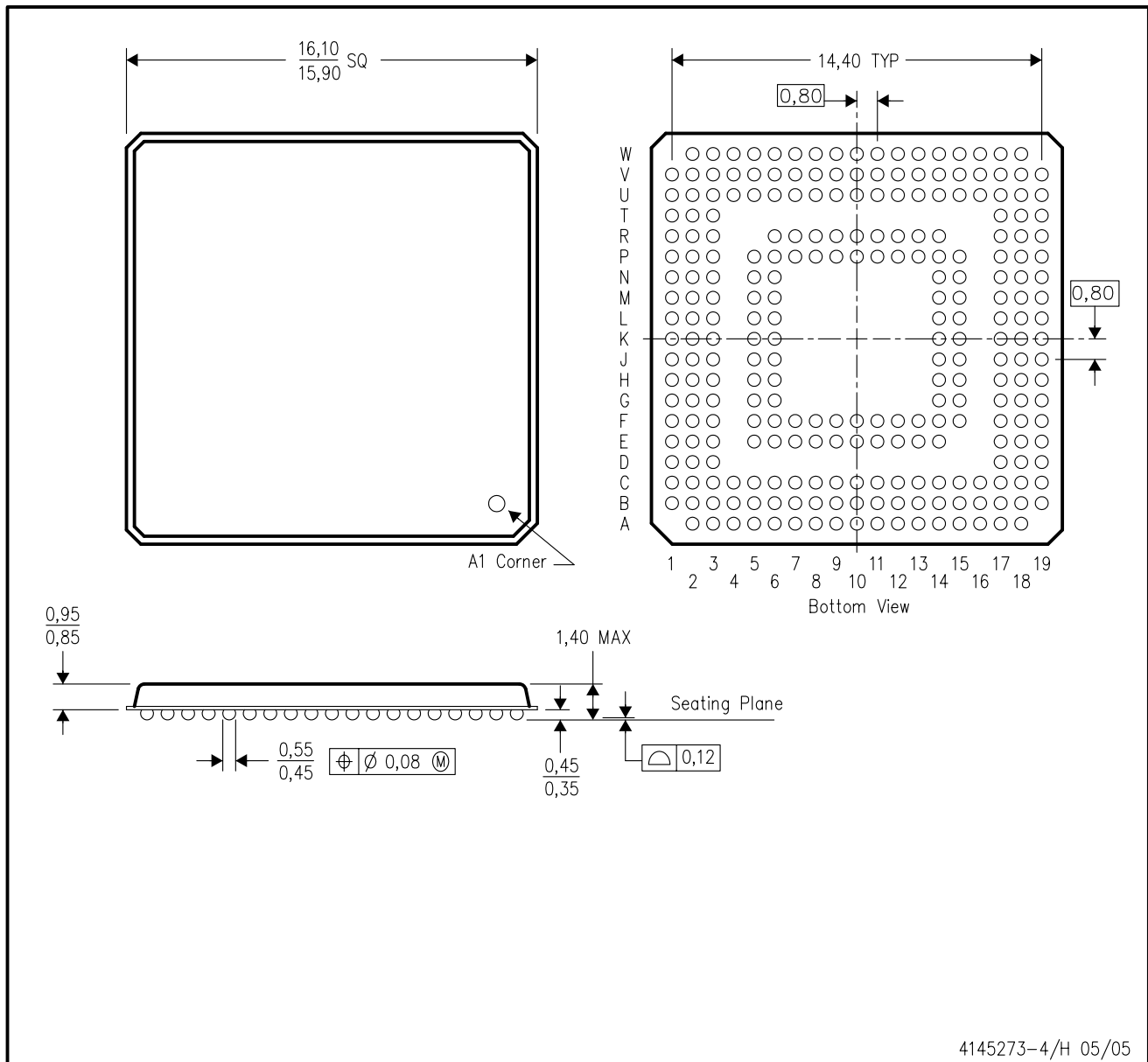


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- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. This is a lead-free solder ball design.

GHK (S-PBGA-N257)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.

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